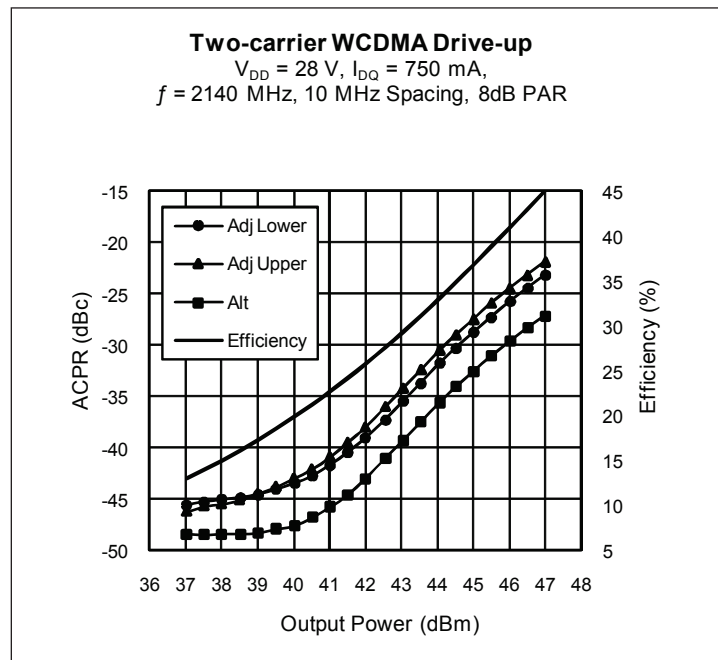


Thermally-Enhanced High Power RF LDMOS FET 80 W, 28 V, 2110 – 2170 MHz

Description

The PTFB210801FA LDMOS FET is designed for use in multi-standard cellular power amplifier applications in the 2110 to 2170 MHz frequency band. Features include input and output matching, high gain and thermally-enhanced packages with earless flanges. Manufactured with Infineon's advanced LDMOS process, this device provides excellent thermal performance and superior reliability.

PTFB210801FA
Package H-37265-2



Features

- Broadband internal matching
- Typical single-carrier WCDMA performance at 2170 MHz, 28 V
 - Average output power = 25 W
 - Linear Gain = 18.5 dB
 - Efficiency = 32.5%
 - Adjacent channel power = -37 dBc
- Typical CW performance, 2170 MHz, 28 V
 - Output power at P_{1dB} = 80 W
 - Efficiency = 55%
- Integrated ESD protection
- Capable of handling 10:1 VSWR @ 28 V, 80 W (CW) output power
- Pb-free and RoHS compliant

RF Characteristics

Two-carrier WCDMA Measurements (tested in Infineon test fixture)

$V_{DD} = 28\text{ V}$, $I_{DQ} = 750\text{ mA}$, $P_{OUT} = 20\text{ W}$ average, $f_1 = 2160\text{ MHz}$, $f_2 = 2170\text{ MHz}$, 3GPP signal, channel bandwidth = 3.84 MHz, peak/average = 8 dB @ 0.01% CCDF

Characteristic	Symbol	Min	Typ	Max	Unit
Gain	G_{ps}	18	18.5	—	dB
Drain Efficiency	η_D	28	31	—	%
Intermodulation Distortion	IMD	—	-30	-28	dBc

All published data at $T_{CASE} = 25^\circ\text{C}$ unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!

DC Characteristics

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}$, $I_{DS} = 10\text{ mA}$	$V_{(BR)DSS}$	65	—	—	V
Drain Leakage Current	$V_{DS} = 28\text{ V}$, $V_{GS} = 0\text{ V}$	I_{DSS}	—	—	1.0	μA
Drain Leakage Current	$V_{DS} = 63\text{ V}$, $V_{GS} = 0\text{ V}$	I_{DSS}	—	—	10.0	μA
On-State Resistance	$V_{GS} = 10\text{ V}$, $V_{DS} = 0.1\text{ V}$	$R_{DS(on)}$	—	0.05	—	Ω
Operating Gate Voltage	$V_{DS} = 30\text{ V}$, $I_{DQ} = 750\text{ mA}$	V_{GS}	2.3	3.0	3.3	V
Gate Leakage Current	$V_{GS} = 10\text{ V}$, $V_{DS} = 0\text{ V}$	I_{GSS}	—	—	1.0	μA

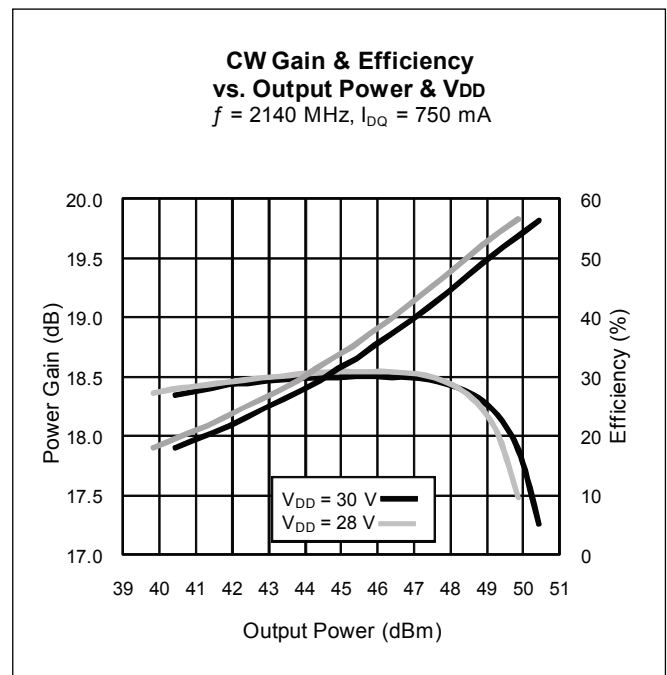
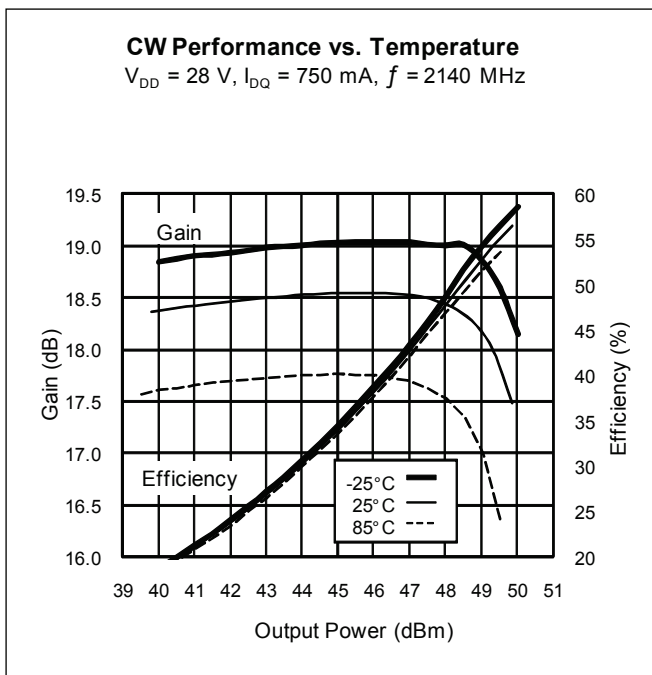
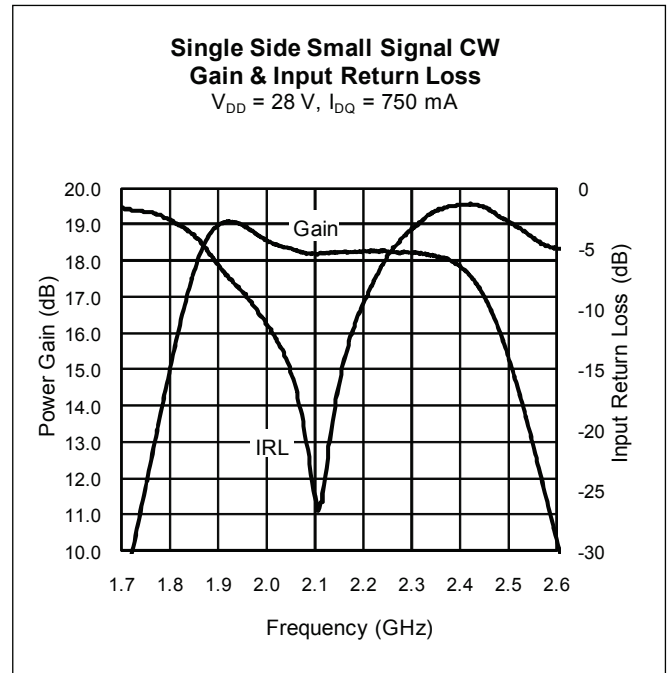
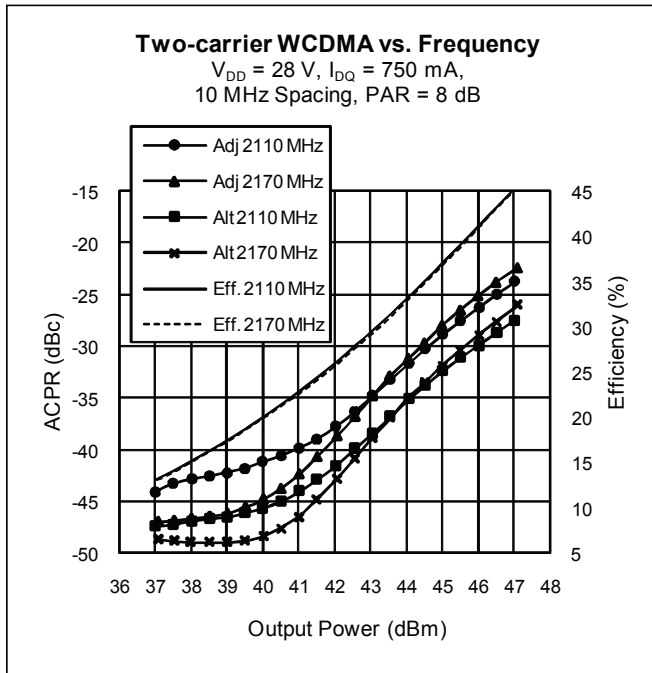
Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	65	V
Gate-Source Voltage	V_{GS}	−6 to +10	V
Junction Temperature	T_J	200	$^{\circ}\text{C}$
Storage Temperature Range	T_{STG}	−40 to +150	$^{\circ}\text{C}$
Thermal Resistance ($T_{CASE} = 70^{\circ}\text{C}$, 80 W CW)	$R_{\theta JC}$	0.50	$^{\circ}\text{C/W}$

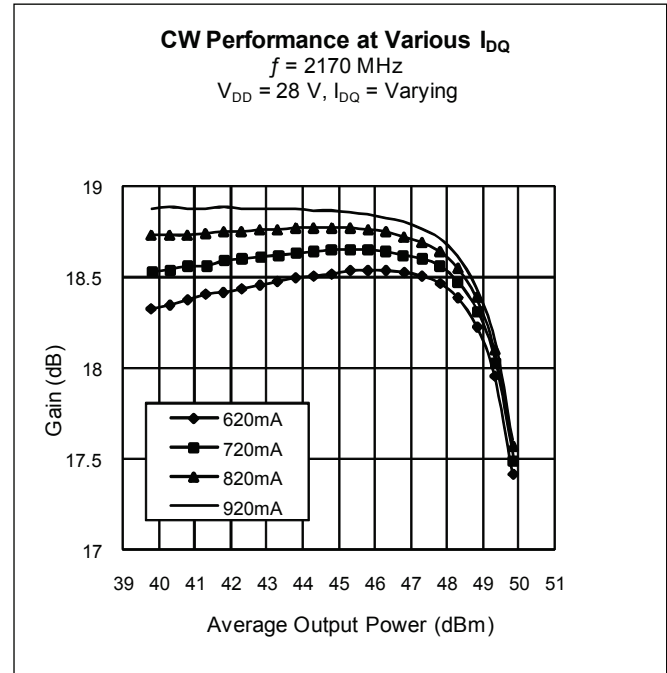
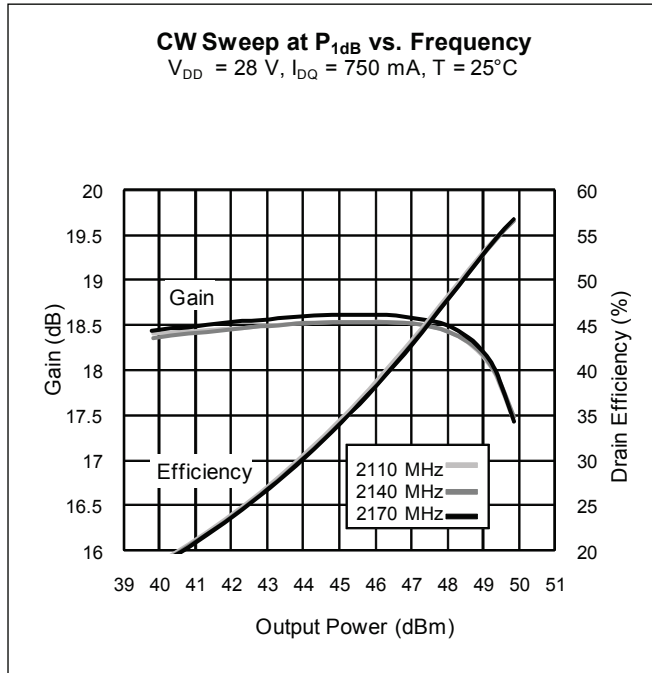
Ordering Information

Type and Version	Order Code	Package Description	Shipping
PTFB210801FA V1 R0	PTFB210801FAV1R0XTMA1	H-37265-2, earless flange	Tape & Reel, 50 pcs
PTFB210801FA V1 R250	PTFB210801FAV1R250XTMA1	H-37265-2, earless flange	Tape & Reel, 250 pcs

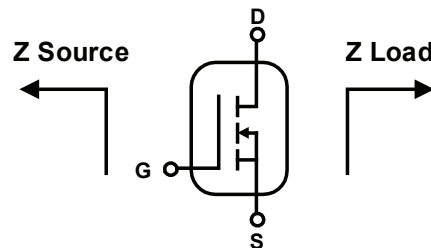
Typical Performance (data taken in a production test fixture)



Typical Performance (cont.)

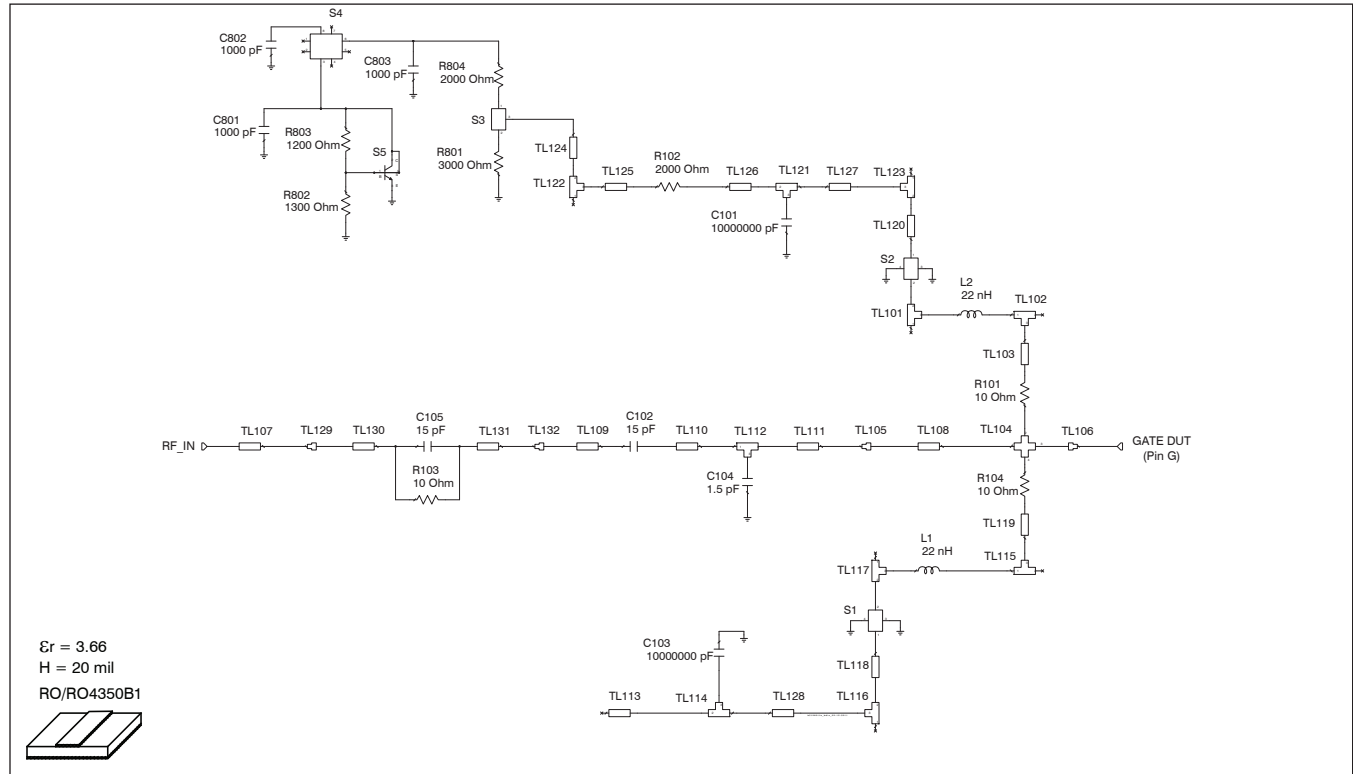


Broadband Circuit Impedance

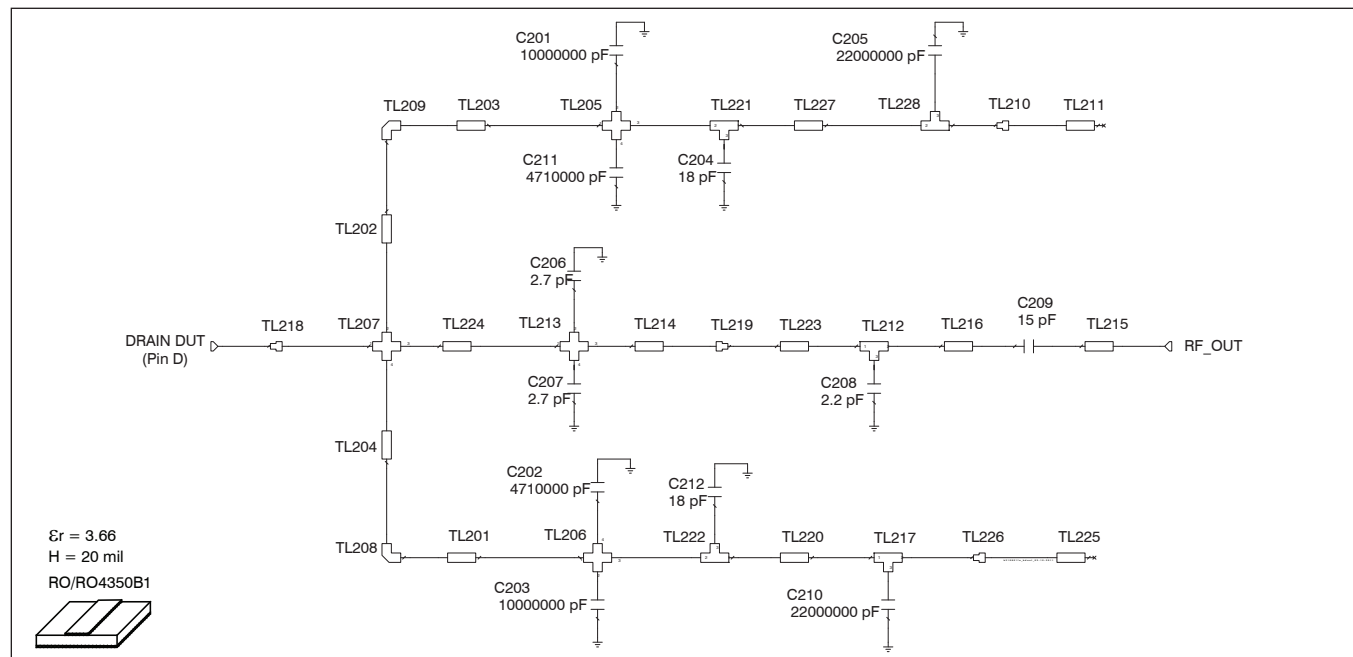


Frequency MHz	Z Source Ω		Z Load Ω	
	R	jX	R	jX
2110	16.3	-4.6	2.2	-4.1
2140	13.6	-4.0	2.3	-4.1
2170	11.3	-2.9	2.2	-4.4

Reference Circuit



Reference circuit input schematic for $f = 2170$ MHz



Reference circuit output schematic for $f = 2170$ MHz

Reference Circuit (cont.)

Description	
DUT	PTFB210801FA
PCB	0.508 mm [.020"] thick, $\epsilon_r = 3.66$, Rogers 4350, 1 oz. copper

Electrical Characteristics at 2170 MHz

Transmission Line	Electrical Characteristics	Dimensions: mm	Dimensions: mils
Input			
TL101, TL117	0.023λ , 35.71 Ω	W1 = 1.905, W2 = 1.905, W3 = 1.905	W1 = 75, W2 = 75, W3 = 75
TL102, TL115	0.012λ , 35.71 Ω	W1 = 1.905, W2 = 1.905, W3 = 1.016	W1 = 75, W2 = 75, W3 = 40
TL103	0.021λ , 54.17 Ω	W = 1.016, L = 1.778	W = 40, L = 70
TL104		W1 = 9.398, W2 = 1.270, W3 = 9.398, W4 = 1.270	W1 = 370, W2 = 50, W3 = 370, W4 = 40
TL105		W1 = 1.024, W2 = 9.398	W1 = 40, W2 = 370
TL106		W1 = 9.398, W2 = 9.398	W1 = 370, W2 = 370
TL107	0.050λ , 53.93 Ω	W = 1.024, L = 4.153	W = 40, L = 164
TL108	0.025λ , 9.59 Ω	W = 9.398, L = 1.905	W = 370, L = 75
TL109	0.019λ , 53.93 Ω	W = 1.024, L = 1.605	W = 40, L = 63
TL110	0.092λ , 53.93 Ω	W = 1.024, L = 7.696	W = 40, L = 303
TL111	0.072λ , 53.93 Ω	W = 1.024, L = 5.994	W = 40, L = 236
TL112	0.011λ , 53.93 Ω	W1 = 1.024, W2 = 1.024, W3 = 0.889	W1 = 40, W2 = 40, W3 = 35
TL113	0.212λ , 47.12 Ω	W = 1.270, L = 17.577	W = 50, L = 692
TL114, TL121	0.039λ , 47.12 Ω	W1 = 1.270, W2 = 1.270, W3 = 3.200	W1 = 50, W2 = 50, W3 = 126
TL116, TL122, TL123	0.016λ , 35.71 Ω	W1 = 1.905, W2 = 1.905, W3 = 1.270	W1 = 75, W2 = 75, W3 = 50
TL118, TL120	0.004λ , 35.71 Ω	W = 1.905, L = 0.361	W = 75, L = 14
TL119	0.021λ , 54.17 Ω	W = 1.016, L = 1.778	W = 40, L = 70
TL124	0.039λ , 35.71 Ω	W = 1.905, L = 3.172	W = 75, L = 125
TL125	0.048λ , 47.12 Ω	W = 1.270, L = 4.013	W = 50, L = 158
TL126	0.071λ , 47.12 Ω	W = 1.270, L = 5.906	W = 50, L = 233
TL127, TL128	0.005λ , 47.12 Ω	W = 1.270, L = 0.406	W = 50, L = 16
TL129		W1 = 1.024, W2 = 2.032	W1 = 40, W2 = 80
TL130, TL131	0.012λ , 34.08 Ω	W = 2.032, L = 1.016	W = 80, L = 40
TL132		W1 = 2.032, W2 = 1.024	W1 = 80, W2 = 40

table continued on page 7

Reference Circuit (cont.)

Electrical Characteristics at 2170 MHz

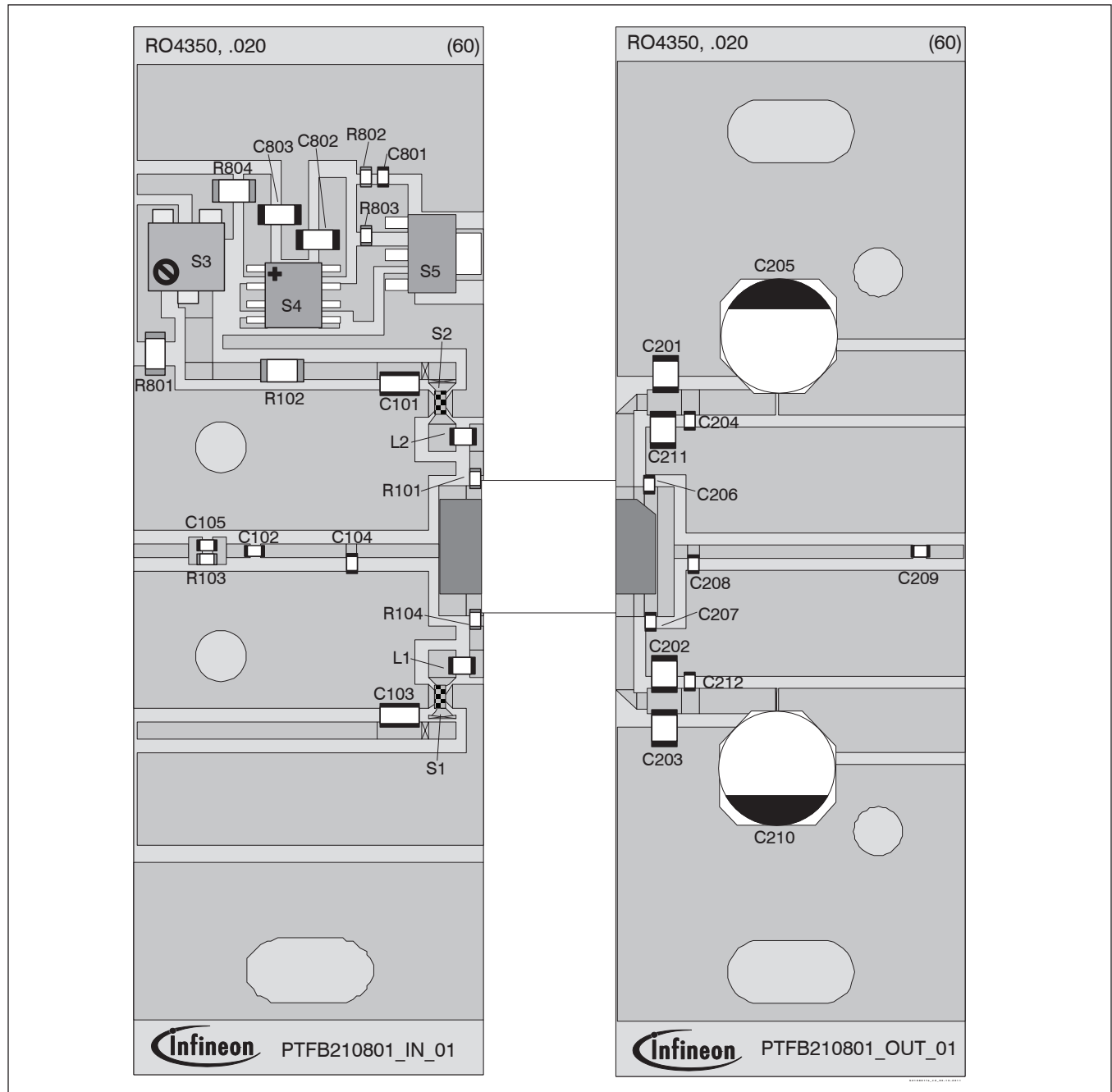
Transmission Line	Electrical Characteristics	Dimensions: mm	Dimensions: mils
Output			
TL201, TL203	0.009λ , 47.12Ω	$W = 1.270$, $L = 0.762$	$W = 50$, $L = 30$
TL202, TL204	0.064λ , 47.12Ω	$W = 1.270$, $L = 5.334$	$W = 50$, $L = 210$
TL205, TL206		$W1 = 1.905$, $W2 = 2.540$, $W3 = 1.905$ $W4 = 2.540$	$W1 = 75$, $W2 = 100$, $W3 = 75$, $W4 = 100$
TL207		$W1 = 9.398$, $W2 = 1.270$, $W3 = 9.398$ $W4 = 1.270$	$W1 = 370$, $W2 = 50$, $W3 = 370$, $W4 = 50$
TL208, TL209		$W = 1.270$	$W = 50$
TL210		$W1 = 0.002$, $W2 = 0.005$, Offset = 0.001	$W1 = 2$, $W2 = 184$, Offset = 55
TL211, TL225	0.172λ , 17.67Ω	$W = 4.674$, $L = 13.564$	$W = 184$, $L = 534$
TL212	0.011λ , 53.93Ω	$W1 = 1.024$, $W2 = 1.024$, $W3 = 0.889$	$W1 = 40$, $W2 = 40$, $W3 = 35$
TL213		$W1 = 9.398$, $W2 = 0.889$, $W3 = 9.398$ $W4 = 0.889$	$W1 = 370$, $W2 = 35$, $W3 = 370$, $W4 = 35$
TL214	0.016λ , 9.59Ω	$W = 9.398$, $L = 1.219$	$W = 370$, $L = 48$
TL215	0.032λ , 53.93Ω	$W = 1.024$, $L = 2.713$	$W = 40$, $L = 107$
TL216	0.185λ , 53.93Ω	$W = 1.024$, $L = 15.491$	$W = 40$, $L = 610$
TL217, TL228	0.002λ , 35.71Ω	$W1 = 1.905$, $W2 = 1.905$, $W3 = 0.127$	$W1 = 75$, $W2 = 75$, $W3 = 5$
TL218		$W1 = 9.398$, $W2 = 9.398$	$W1 = 370$, $W2 = 370$
TL219		$W1 = 1.024$, $W2 = 9.398$	$W1 = 40$, $W2 = 370$
TL220, TL227	0.068λ , 35.71Ω	$W = 1.905$, $L = 5.588$	$W = 75$, $L = 220$
TL221, TL222	0.016λ , 35.71Ω	$W1 = 1.905$, $W2 = 1.905$, $W3 = 1.270$	$W1 = 75$, $W2 = 75$, $W3 = 50$
TL223	0.012λ , 53.93Ω	$W = 1.024$, $L = 0.991$	$W = 40$, $L = 39$
TL224	0.011λ , 9.59Ω	$W = 9.398$, $L = 0.813$	$W = 370$, $L = 32$
TL226		$W1 = 0.002$, $W2 = 0.005$, Offset = -0.001	$W1 = 2$, $W2 = 184$, Offset = -55

Reference Circuit (cont.)

Circuit Assembly Information

Test Fixture Part No. LTN/PTFB210801FA

Find Gerber files for this test fixture on the Infineon Web site at <http://www.infineon.com/rfpower>



Reference circuit assembly diagram (not to scale)

Reference Circuit (cont.)

Components Information

Component	Description	Suggested Manufacturer	P/N
Input			
C101, C103	Capacitor, 10 μ F	Digi-Key	490-4393-2-ND
C102, C105	Chip capacitor, 15 pF	ATC	800A150GT
C104	Chip capacitor, 1.5 pF	ATC	800A1T5GR
C801, C802, C803	Capacitor, 1000 pF	Digi-Key	PCC1772CT-ND
L1, L2	Inductor, 22 nH	Coilcraft	0805CS-220X_BG
R101, R103, R104	Resistor, 10 Ω	Digi-Key	P10GCT-ND
R102, R804	Resistor, 2000 Ω	Digi-Key	P2.0KECT-ND
R801	Resistor, 3000 Ω	Digi-Key	P3.0KECT-ND
R802	Resistor, 1300 Ω	Digi-Key	P1.3KGECT-ND
R803	Resistor, 1200 Ω	Digi-Key	P1.2KGECT-ND
S1, S2	EMI Suppression Capacitor	Digi-Key	NFM18PS105R0J3D
S3	Potentiometer, 2k Ω	Digi-Key	3224W-202ECT-ND
S4	Voltage Regulator	Digi-Key	LM7805
S5	Transistor	Digi-Key	BCP56
Output			
C201, C203	Capacitor, 10 μ F	Digi-Key	587-1818-2-ND
C202, C211	Chip capacitor, 4.71 μ F	ATC	490-1864-2-ND
C204, C212	Chip capacitor, 18 pF	ATC	800A180JT
C205, C210	Capacitor, 22 μ F	Digi-Key	PCE4444TR-ND
C206, C207	Chip capacitor, 2.7 pF	ATC	800A2R7BT
C208	Chip capacitor, 2.2 pF	ATC	800A2R2BT
C209	Chip capacitor, 15 pF	ATC	800A150GT

Package Outline Specifications

Package H-37265-2

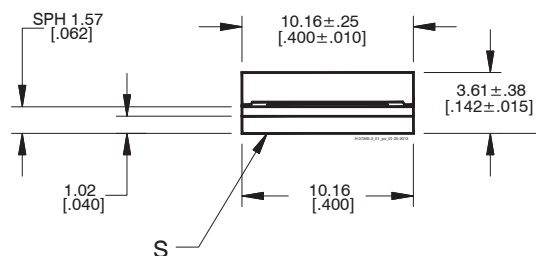
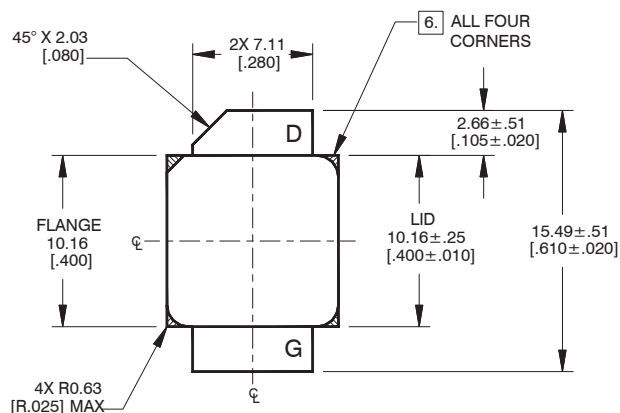


Diagram Notes—unless otherwise specified:

1. Interpret dimensions and tolerances per ASME Y14.5M-1994.
2. Primary dimensions are mm. Alternate dimensions are inches.
3. All tolerances ± 0.127 [.005] unless specified otherwise.
4. Pins: D = drain, S = source, G = gate.
5. Lead thickness: 0.10 +0.051/-0.025 [.004 +.002/-0.001].
6. Exposed metal plane on top and bottom of ceramic insulator.
7. Gold plating thickness: 1.14 ± 0.38 micron [45 ± 15 microinch]

Find the latest and most complete information about products and packaging at the Infineon Internet page
<http://www.infineon.com/rfpower>

Revision History

Revision	Date	Data Sheet Type	Page	Subjects (major changes since last revision)
01	2011-03-30	Production	All	Data Sheet reflects advance specification for product development
01.1	2016-06-14	Production	2	Updated ordering information

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